

HEX BUFFERS WITH OPEN DRAIN OUTPUTS

Description

The 74LVC04A provides six independent inverter buffers. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using IOFF. The IOFF circuitry disables the output preventing damaging current backflow when the device is powered down.

The gates perform the positive Boolean function:

 $Y = \overline{A}$

Features

Notes:

- Wide Supply Voltage Range from 1.65V to 5.5V
- Sinks or sources 24mA at V_{CC} = 3.3V
- CMOS low power consumption
- IOFF Supports Partial-Power-Down Mode Operation
- Inputs or outputs accept up to 5.5V
- Inputs can be driven by 3.3 V or 5.5V allowing for voltage translation applications.
- ESD Protection Exceeds JESD 22
 - 200-V Machine Model (A115-A)
 - 2000-V Human Body Model (A114-A)
 - Exceeds 1000-V Charged Device Model (C101C)
 - Latch-Up Exceeds 250mA per JESD 78, Class II
- Range of Package Options SO-14 and TSSOP-14

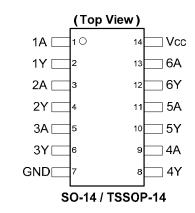
<1000ppm antimony compounds.

• Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

• Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments



Applications

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- Wide array of products such as:
 - PCs, networking, notebooks, ultrabooks, netbooks
 - Computer peripherals, hard drives, CD/DVD ROM
 - TV, DVD, DVR, set top box

74LVC04A Document number: DS35258 Rev. 3 - 2

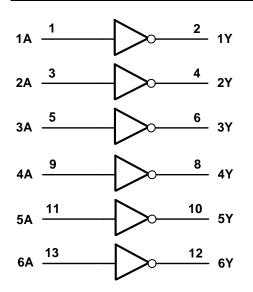
See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and



Pin Descriptions

Pin Number	Pin Name	Description
1	1A	Data Input
2	1Y	Data Output
3	2A	Data Input
4	2Y	Data Output
5	ЗA	Data Input
6	3Y	Data Output
7	GND	Ground
8	4Y	Data Output
9	4A	Data Input
10	5Y	Data Output
11	5A	Data Input
12	6Y	Data Output
13	6A	Data Input
14	V _{CC}	Supply Voltage

Logic Diagram



Function Table

Inputs	Outputs
Α	Y
н	L
L	Н



Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
Vcc	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or I _{OFF} state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to V _{CC} +0.5	V
lık	Input Clamp Current VI<0	-50	mA
I _{OK}	Output Clamp Current V _O <0	-50	mA
lo	Continuous output current	50	mA
	Continuous current through Vdd or GND	±100	mA
TJ Operating Junction Temperature		-40 to +150	°C
T _{STG} Storage Temperature		-65 to +150	°C
P _{TOT} Total Power Dissipation		500	mW

Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Note: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

Recommended Operating Conditions (Note 5) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit	
V _{CC}	Supply Voltage		1.65	5.5	V	
VI	Input Voltage		0	5.5	V	
		Active Mode	0	V _{CC}	V	
Vo	Output Voltage	V _{CC} = 0V; Power Down Mode	0	5.5	V	
		V _{CC} = 1.65V to 2.7V		20		
Δt/ΔV	Input transition rise or fall rate	V _{CC} = 2.7V to 5.5V		10	ns/V	
TA	Operating free-air temperature		-40	+125	°C	

Notes: 5. Unused inputs should be held at V_{CC} or Ground.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

		T		$T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$		T _A = -40°C	to +125°C	
Symbol	Parameter	Test Conditions	V _{cc}	Min	Max	Min	Max	Unit
			1.65V to 1.95V	0.65 X V _{CC}		0.65 X V _{CC}		v
	, High-level Input		2.3V to 2.7V	1.7		1.6		
V _{IH}	Voltage		2.7V to 3.6V	2.0		2.0		
			4.5V to 5.5V	0.7 X V _{CC}		2.0		
			1.65V to 1.95V		0.35 X V _{CC}		0.35 X V _{CC}	
N/	Low-level input		2.3V to 2.7V		0.7		0.7	Ň
V _{IL}	voltage		2.7V to 3.6V		0.8		0.8	V
			4.5V to 5.5V		0.3 X V _{CC}		0.3 X V _{CC}	
		I _{OH} = -100µА	1.65V to 3.6V	V _{CC} -0.2		V _{CC} - 0.3		V
		I _{OH} = -4mA	1.65V	1.2				
M	High Level Output Voltage	I _{OH} = -8mA	2.3V	1.9				
V _{OH}		10 - 10 1	2.7V	2.2		2.05		V
		I _{OH} = -12mA	3.0V	2.3		2.1		
		I _{OH} = -24mA	3.0V	2.2		2.0		
		Ι _{ΟΗ} = 100μΑ	1.65V to 5.5V		0.2		0.3	
		I _{OH} = 4mA	1.65V		0.45		0.6	
N/	High-level	I _{OH} = 8mA	2.3V		0.70		0.85	
V _{OL}	Output Voltage	1. 101	2.7V		0.40		0.6	V
		I _{OH} = 12mA	3.0V		0.55		0.6	
		I _{OH} =-24mA	3.0V		0.55		0.6	
lı	Input Current	V _I =GND to 5.5V	3.6V		±5		±20	μA
I _{OFF}	Power Down Leakage Current	V_{I} or $V_{O} = 0V$ to 3.6V	0		10		20	μA
I _{CC}	Supply Current	$V_1 = GND \text{ or } V_{CC}$ $I_0 = 0$	3.6V		10		40	μA
ΔI _{CC}	Additional Supply Current	One input at V _{CC} – 0.6V Other	2.7V to 3.6V		500		5000	μA



Switching Characteristics

Symbol	Deveryoter	Test	V	T,	a = +25°	C	-40°C to	o +85°C	-40°C to	+125°C	Unit
Symbol	Parameter	Conditions	ons V _{cc}	Min	Тур	Max	Min	Max	Min	Max	Unit
		Figure 1	1.65V to1.95V	0.5	4.1	7.5	0.5	8.0	0.5	9.5	
	Propagation		2.3V to 2.7V	0.5	3.6	7.0	0.5	7.5	0.5	9.0	
tpD	Delay A_N to Y_N		2.7V	0.5	3.0	5.3	0.5	5.5	0.5	7.0	ns
		3V to 3.6V	0.5	2.5	4.3	0.5	4.5	0.5	6.0		
tsk(0)	Output Skew Time		3V to 3.6V					1.0		1.5	ns

Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

Parameter		Test	V _{CC} = 1.8V	$V_{CC} = 2.5V$	$V_{CC} = 3.3V$	$V_{CC} = 5V$	Unit
		Conditions	Тур	Тур	Тур	Тур	
C_{pd}	Power dissipation capacitance per gate	f = 10 MHz	7.0	7.5	8.0	8.6	pF
Cı	Input Capacitance	$V_i = V_{CC} - or$ GND	4	4	4	4	pF

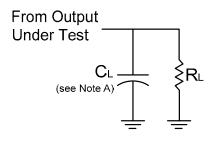
Package Characteristics

Symbol	Parameter	Test Conditions	V _{cc}	Min	Тур	Max	Unit
0	Thermal Resistance	SO-14	(Note 6)		TBD		°0.44
θ _{JA}	Junction-to-Ambient	nction-to-Ambient TSSOP-14			159		°C/W
0	Thermal Resistance	SO-14	(Nata C)		TBD		°C/W
θ _{JC}	Junction-to-Case	TSSOP-14	(Note 6)		25		C/vv

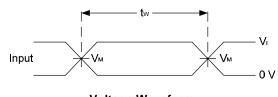
Note: 6. Test condition for SO-14 and TSSOP-14 : Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

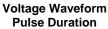


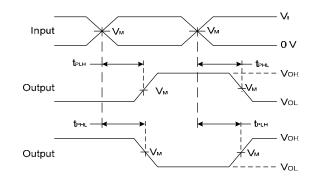
Parameter Measuement Information



Vee	Inp	outs	V.,	C	D.
Vcc	VI	V_1 t_r/t_f V_M	CL	RL	
1.8V ±0.15V	Vcc	≤2ns	V _{CC} /2	30pF	1ΚΩ
2.5V ±0.2V	V _{CC}	≤2ns	V _{CC} /2	30pF	500Ω
3.3V ±0.3V	3V	≤2.5ns	1.5V	50pF	500Ω
5V ±0.5V	Vcc	≤2.5ns	V _{CC} /2	50pF	500Ω







Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

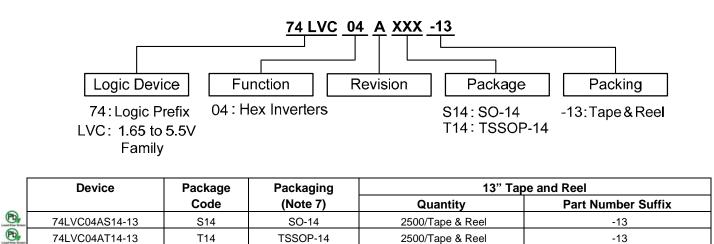
Notes: A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate \leq 10 MHz. C. Inputs are measured separately one transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{PD} .

Figure 1. Load Circuit and Voltage Waveforms

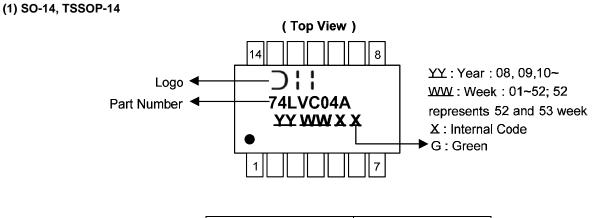


Ordering Information



-	74LVC04AT14-13	T14	TSSOP-14	2500/Tape & Reel	
	Notes: 7. The taping orientation	n and tape details ca	n be found at http://www.di	odes.com/datasheets/ap02007.pdf	

Marking Information

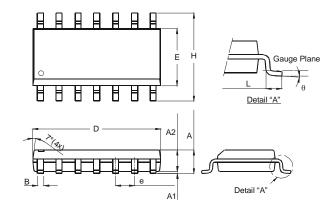


Part Number	Package
74LVC04AS14	SO-14
74LVC04AT14	TSSOP-14



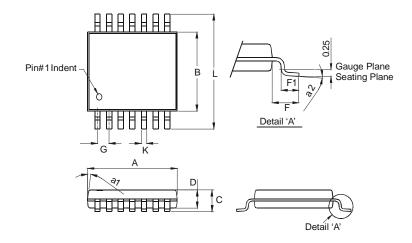
Package Outline Dimensions (All dimensions in mm.)

Package Type: SO-14



	SO-14	
Dim	Min	Max
Α	1.47	1.73
A1	0.10	0.25
A2	1.45	Тур
В	0.33	0.51
D	8.53	8.74
Е	3.80	3.99
е	1.27	Тур
Н	5.80	6.20
L	0.38	1.27
θ	0°	8°
All Di	mension	s in mm

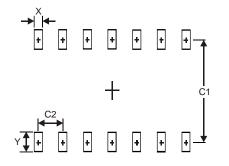
Package Type: TSSOP-14



TSSOP-14		
Dim	Min	Max
a1	7° (4X)	
a2	0°	8°
Α	4.9	5.10
в	4.30	4.50
C	_	1.2
D	0.8	1.05
F	1.00 Typ	
F1	0.45	0.75
G	0.65 Typ	
К	0.19	0.30
L	6.40 Тур	
All Dimensions in mm		

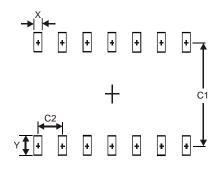


Package Type: SO-14



Dimensions	Value (in mm)
Х	0.60
Y	1.50
C1	5.4
C2	1.27

Package Type: TSSOP-14



Dimensions	Value (in mm)
Х	0.45
Y	1.45
C1	5.9
C2	0.65



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